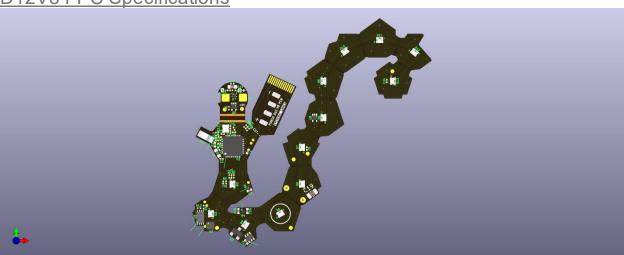
D12V8 FPC Specifications



<u>PCB Type</u>: Flexible PCB <u>Board type</u>: Single pieces

Layer: 2 Layers

Material: Polyimide Flex: FPC Thickness: 0.13 mm

Solder Mask (Coverlay): Black Coverlay

Silkscreen: White / Black

Stiffener: BOT FR4: 0.15 mm

filename: Main-B_Stiffener.gbr

<u>Surface Finish</u>: Immersion gold (ENIG) (1U") <u>Finished Copper</u>: 0.5 oz **Annealed** Cu (18µm)

E-test: 100%

3M/Tesa tape: BOT

Glue: Main-B_3M_Adhesive.gbr

Backing Tape: Main-B_3M_Backing.gbr

SMT: TOP